

|                     |       |
|---------------------|-------|
| $V_{DSS}$           | 200V  |
| $R_{DS(on)}$ (Max.) | 325mΩ |
| $I_D$               | 7.5A  |
| $P_D$               | 20W   |

### ●Features

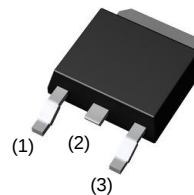
- 1) Low on-resistance.
- 2) Fast switching speed.
- 3) Drive circuits can be simple.
- 4) Parallel use is easy.
- 5) Pb-free lead plating ; RoHS compliant
- 6) 100% Avalanche tested

### ●Application

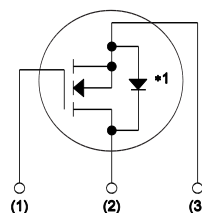
Switching Power Supply  
Automotive Motor Drive  
Automotive Solenoid Drive

### ●Outline

CPT3  
(SC-63)  
<SOT-428>



### ●Inner circuit



(1) Gate  
(2) Drain  
(3) Source

\*1 BODY DIODE

### ●Packaging specifications

|      |                           |        |
|------|---------------------------|--------|
| Type | Packaging                 | Taping |
|      | Reel size (mm)            | 330    |
|      | Tape width (mm)           | 16     |
|      | Basic ordering unit (pcs) | 2,500  |
|      | Taping code               | TL     |
|      | Marking                   | C07N20 |

### ●Absolute maximum ratings ( $T_a = 25^\circ\text{C}$ )

| Parameter                      |                               | Symbol             | Value       | Unit             |
|--------------------------------|-------------------------------|--------------------|-------------|------------------|
| Drain - Source voltage         |                               | $V_{DSS}$          | 200         | V                |
| Continuous drain current       | $T_c = 25^\circ\text{C}$      | $I_D^{*1}$         | $\pm 7.5$   | A                |
|                                | $T_c = 100^\circ\text{C}$     | $I_D^{*1}$         | $\pm 4.1$   | A                |
| Pulsed drain current           |                               | $I_{D,pulse}^{*2}$ | $\pm 30$    | A                |
| Gate - Source voltage          |                               | $V_{GSS}$          | $\pm 30$    | V                |
| Avalanche energy, single pulse |                               | $E_{AS}^{*3}$      | 4.13        | mJ               |
| Avalanche current              |                               | $I_{AS}^{*3}$      | 3.75        | A                |
| Power dissipation              | $T_c = 25^\circ\text{C}$      | $P_D$              | 20          | W                |
|                                | $T_a = 25^\circ\text{C}^{*4}$ | $P_D$              | 0.85        | W                |
| Junction temperature           |                               | $T_j$              | 150         | $^\circ\text{C}$ |
| Range of storage temperature   |                               | $T_{stg}$          | -55 to +150 | $^\circ\text{C}$ |

### ●Thermal resistance

| Parameter                                            | Symbol     | Values |      |      | Unit |
|------------------------------------------------------|------------|--------|------|------|------|
|                                                      |            | Min.   | Typ. | Max. |      |
| Thermal resistance, junction - case                  | $R_{thJC}$ | -      | -    | 6.25 | °C/W |
| Thermal resistance, junction - ambient <sup>*4</sup> | $R_{thJA}$ | -      | -    | 147  | °C/W |
| Soldering temperature, wavesoldering for 10s         | $T_{sold}$ | -      | -    | 265  | °C   |

### ●Electrical characteristics ( $T_a = 25^\circ\text{C}$ )

| Parameter                                   | Symbol            | Conditions                                                | Values |      |           | Unit          |
|---------------------------------------------|-------------------|-----------------------------------------------------------|--------|------|-----------|---------------|
|                                             |                   |                                                           | Min.   | Typ. | Max.      |               |
| Drain - Source breakdown voltage            | $V_{(BR)DSS}$     | $V_{GS} = 0V, I_D = 1mA$                                  | 200    | -    | -         | V             |
| Zero gate voltage drain current             | $I_{DSS}$         | $V_{DS} = 200V, V_{GS} = 0V$<br>$T_j = 25^\circ\text{C}$  | -      | -    | 10        | $\mu\text{A}$ |
|                                             |                   | $V_{DS} = 200V, V_{GS} = 0V$<br>$T_j = 125^\circ\text{C}$ | -      | -    | 100       |               |
| Gate - Source leakage current               | $I_{GSS}$         | $V_{GS} = \pm 30V, V_{DS} = 0V$                           | -      | -    | $\pm 100$ | nA            |
| Gate threshold voltage                      | $V_{GS(th)}$      | $V_{DS} = 10V, I_D = 1mA$                                 | 3.25   | -    | 5.25      | V             |
| Static drain - source on - state resistance | $R_{DS(on)}^{*5}$ | $V_{GS} = 10V, I_D = 3.75A$                               | -      | 250  | 325       | $m\Omega$     |
|                                             |                   | $V_{GS} = 10V, I_D = 3.75A$<br>$T_j = 125^\circ\text{C}$  | -      | 515  | 670       |               |
| Forward transfer admittance                 | $g_{fs}$          | $V_{DS} = 10V, I_D = 3.75A$                               | 1.5    | 3.0  | -         | S             |

**●Electrical characteristics ( $T_a = 25^\circ\text{C}$ )**

| Parameter                    | Symbol            | Conditions                          | Values |      |      | Unit |
|------------------------------|-------------------|-------------------------------------|--------|------|------|------|
|                              |                   |                                     | Min.   | Typ. | Max. |      |
| Input capacitance            | $C_{iss}$         | $V_{GS} = 0V$                       | -      | 755  | -    | pF   |
| Output capacitance           | $C_{oss}$         | $V_{DS} = 25V$                      | -      | 55   | -    |      |
| Reverse transfer capacitance | $C_{rss}$         | $f = 1\text{MHz}$                   | -      | 25   | -    |      |
| Turn - on delay time         | $t_{d(on)}^{*5}$  | $V_{DD} \approx 100V, V_{GS} = 10V$ | -      | 20   | -    | ns   |
| Rise time                    | $t_r^{*5}$        | $I_D = 3.75A$                       | -      | 22   | -    |      |
| Turn - off delay time        | $t_{d(off)}^{*5}$ | $R_L = 26.67\Omega$                 | -      | 24   | -    |      |
| Fall time                    | $t_f^{*5}$        | $R_G = 10\Omega$                    | -      | 12   | -    |      |

**●Gate Charge characteristics ( $T_a = 25^\circ\text{C}$ )**

| Parameter            | Symbol          | Conditions                        | Values |      |      | Unit |
|----------------------|-----------------|-----------------------------------|--------|------|------|------|
|                      |                 |                                   | Min.   | Typ. | Max. |      |
| Total gate charge    | $Q_g^{*5}$      | $V_{DD} \approx 100V$             | -      | 15   | -    | nC   |
| Gate - Source charge | $Q_{gs}^{*5}$   | $I_D = 7.5A$                      | -      | 6    | -    |      |
| Gate - Drain charge  | $Q_{gd}^{*5}$   | $V_{GS} = 10V$                    | -      | 6    | -    |      |
| Gate plateau voltage | $V_{(plateau)}$ | $V_{DD} \approx 100V, I_D = 7.5A$ | -      | 7.4  | -    | V    |

**●Body diode electrical characteristics (Source-Drain)( $T_a = 25^\circ\text{C}$ )**

| Parameter                 | Symbol        | Conditions                | Values |      |      | Unit |
|---------------------------|---------------|---------------------------|--------|------|------|------|
|                           |               |                           | Min.   | Typ. | Max. |      |
| Continuous source current | $I_S^{*1}$    | $T_c = 25^\circ\text{C}$  | -      | -    | 7.5  | A    |
| Pulsed source current     | $I_{SM}^{*2}$ |                           | -      | -    | 30   | A    |
| Forward voltage           | $V_{SD}^{*5}$ | $V_{GS} = 0V, I_S = 7.5A$ | -      | -    | 1.5  | V    |
| Reverse recovery time     | $t_{rr}^{*5}$ | $I_S = 3.75A$             | -      | 75   | -    | ns   |
| Reverse recovery charge   | $Q_{rr}^{*5}$ | $di/dt = 100A/\mu s$      | -      | 220  | -    | nC   |

\*1 Limited only by maximum temperature allowed.

\*2  $P_w \leq 10\mu s$ , Duty cycle  $\leq 1\%$

\*3  $L \approx 500\mu H$ ,  $V_{DD} = 50V$ ,  $R_g = 25\Omega$ , starting  $T_j = 25^\circ\text{C}$

\*4 Mounted on a epoxy PCB FR4 (20mm × 20mm × 0.8mm)

\*5 Pulsed

●Electrical characteristic curves

Fig.1 Power Dissipation Derating Curve

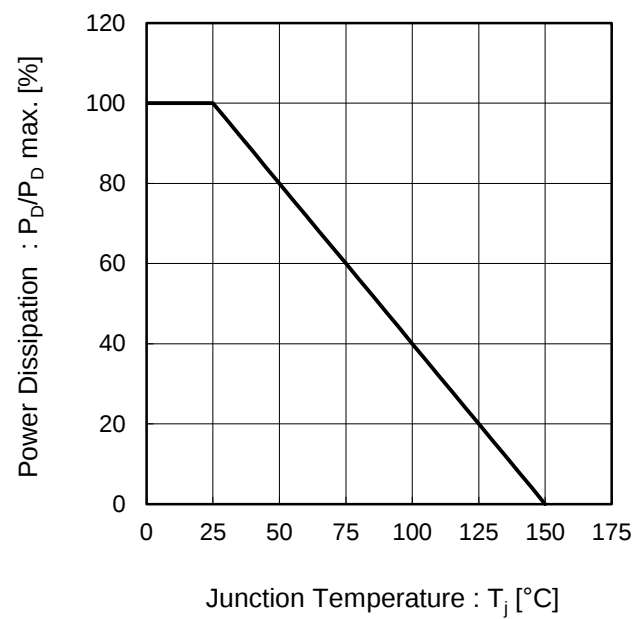


Fig.2 Maximum Safe Operating Area

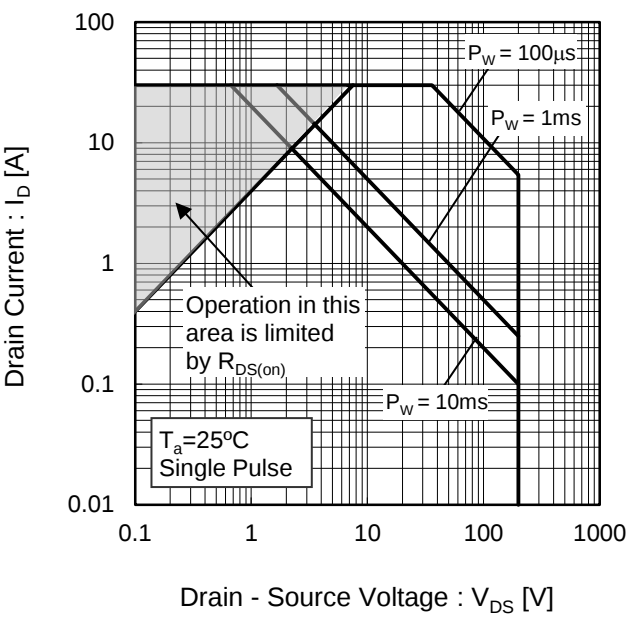
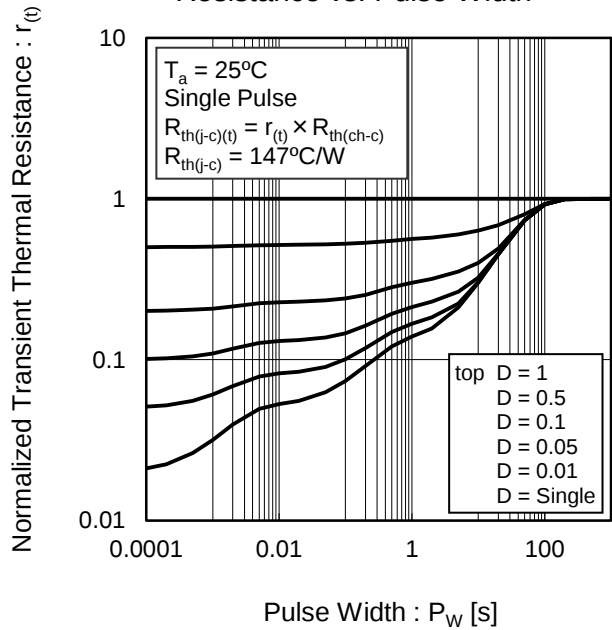


Fig.3 Normalized Transient Thermal Resistance vs. Pulse Width



●Electrical characteristic curves

Fig.4 Avalanche Current vs Inductive Load

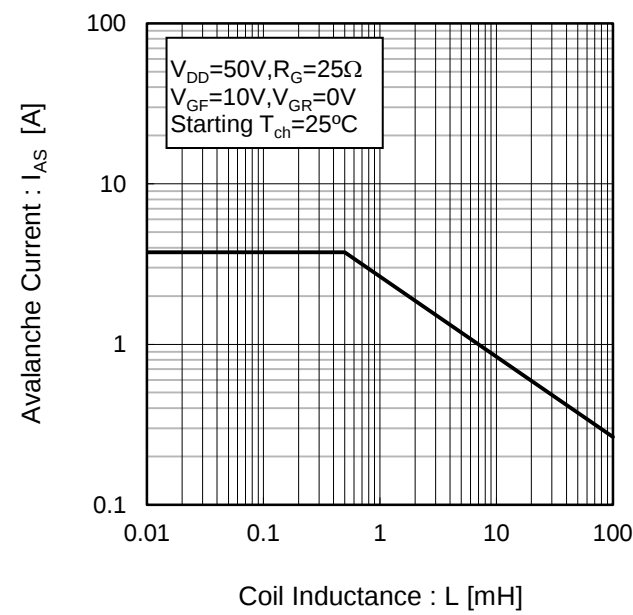


Fig.5 Avalanche Energy Derating Curve vs Junction Temperature

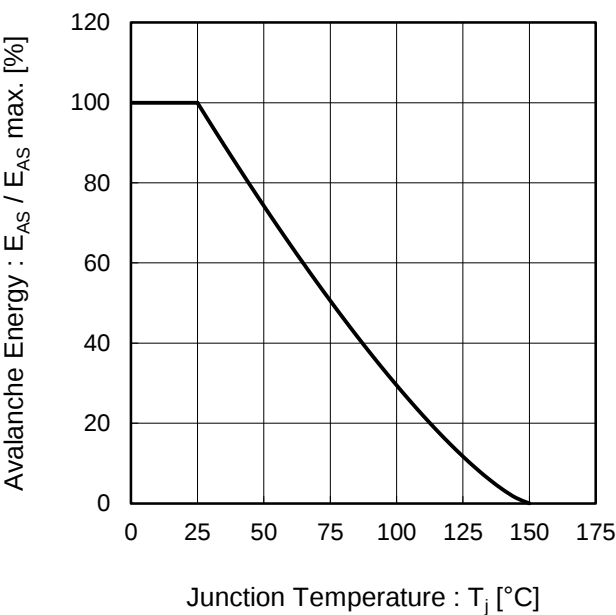


Fig.6 Typical Output Characteristics(I)

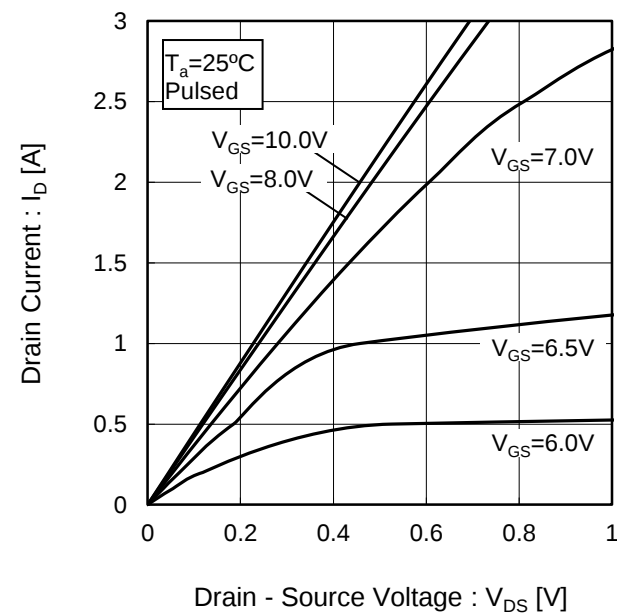
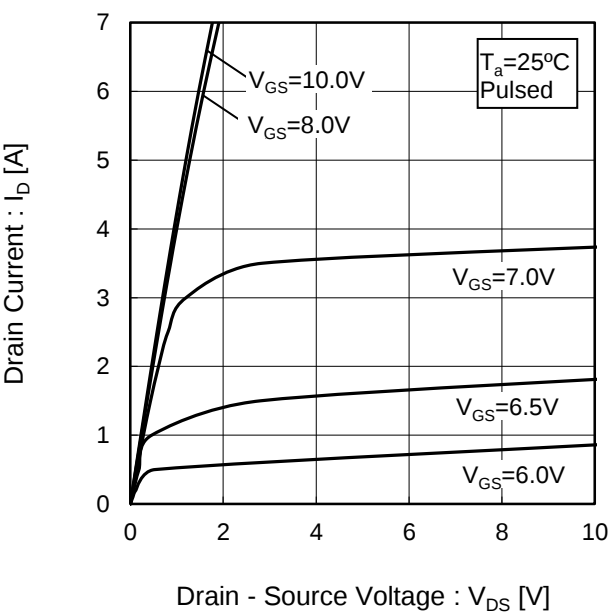


Fig.7 Typical Output Characteristics(II)



●Electrical characteristic curves

Fig.8 Breakdown Voltage  
vs. Junction Temperature

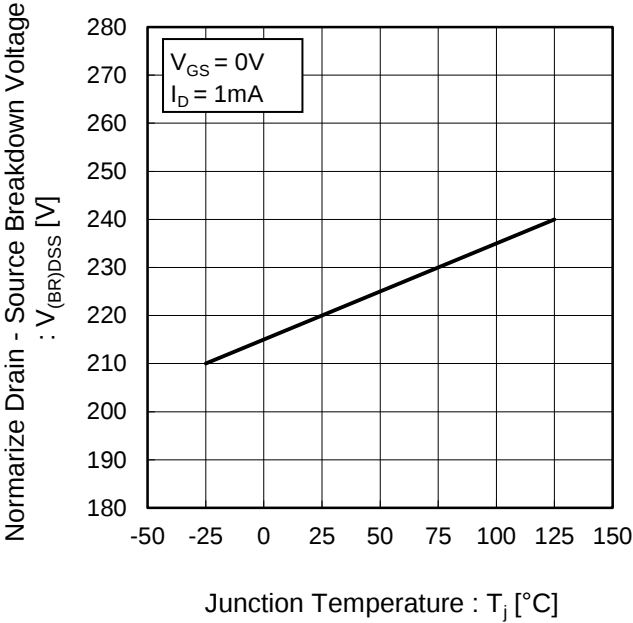


Fig.9 Typical Transfer Characteristics

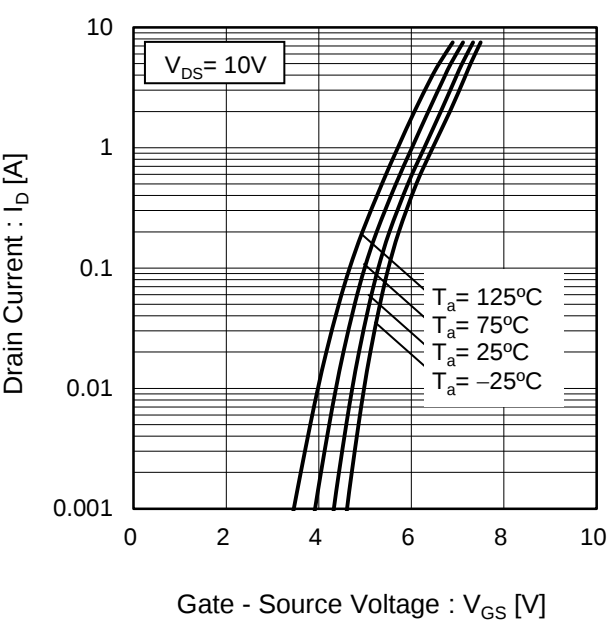


Fig.10 Gate Threshold Voltage  
vs. Junction Temperature

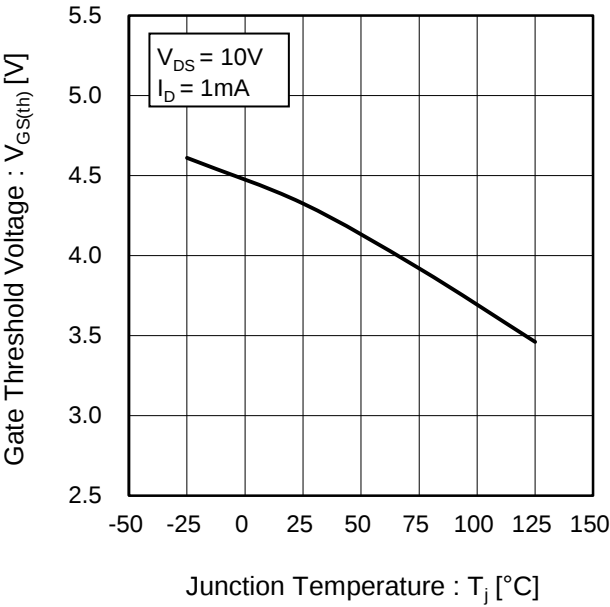
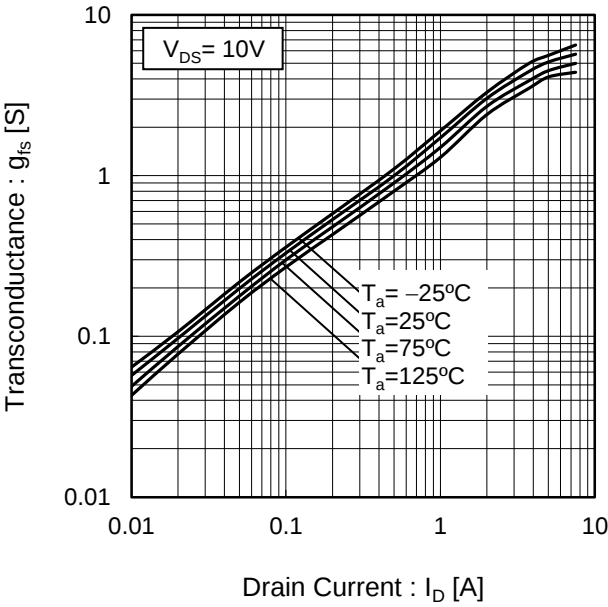


Fig.11 Transconductance vs. Drain Current



●Electrical characteristic curves

Fig.12 Static Drain - Source On - State Resistance vs. Gate Source Voltage

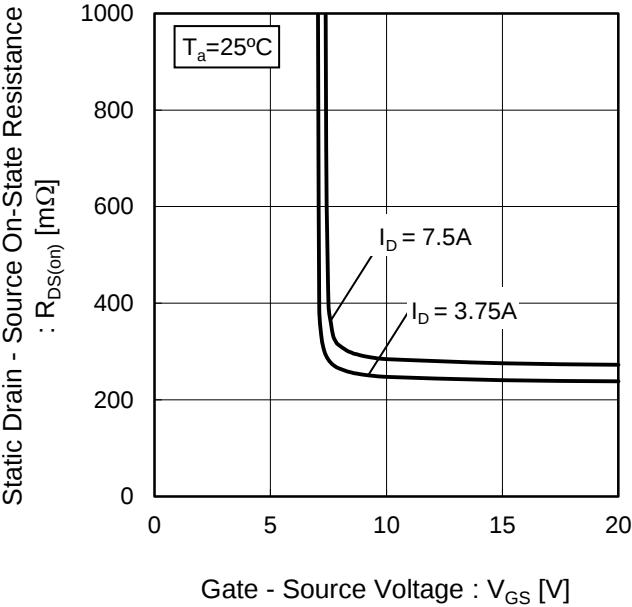


Fig.13 Static Drain - Source On - State Resistance vs. Drain Current(I)

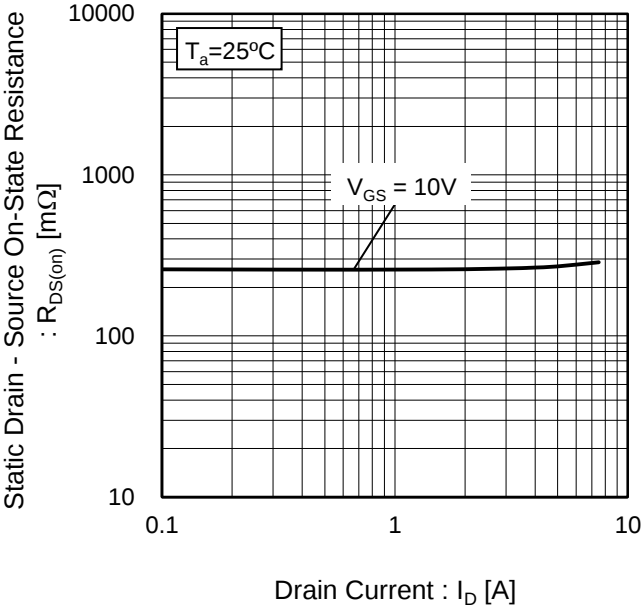
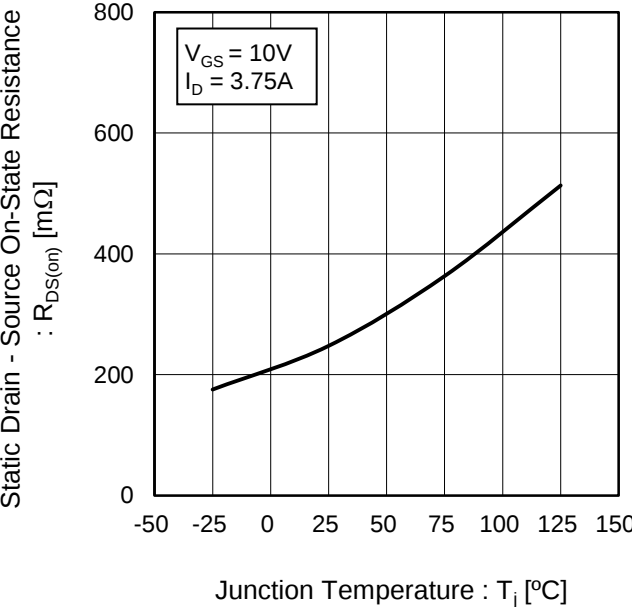


Fig.14 Static Drain - Source On - State Resistance vs. Junction Temperature



●Electrical characteristic curves

Fig.15 Static Drain - Source On - State Resistance vs. Drain Current(I)

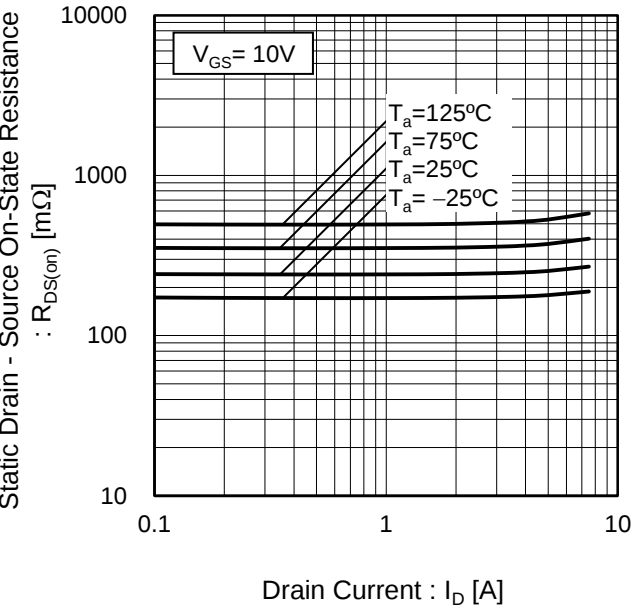
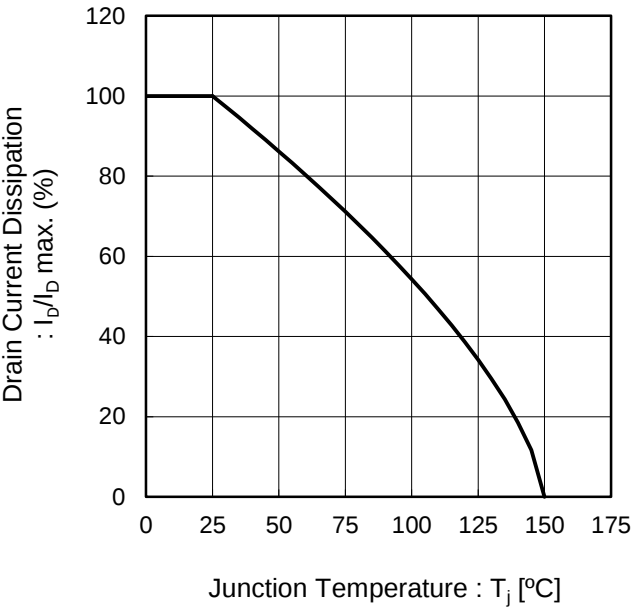


Fig.16 Drain Current Derating Curve



●Electrical characteristic curves

Fig.17 Typical Capacitance vs. Drain - Source Voltage

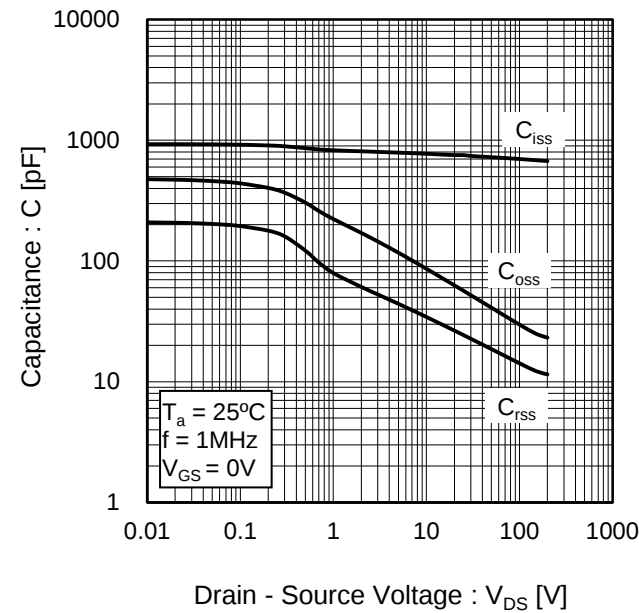


Fig.18 Switching Characteristics

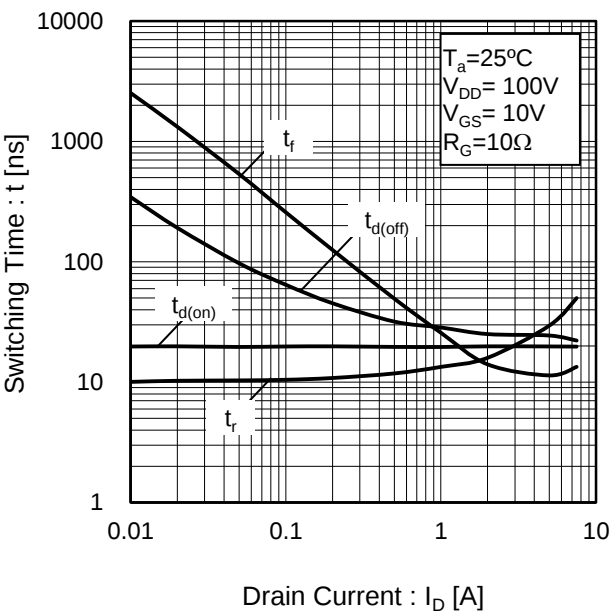
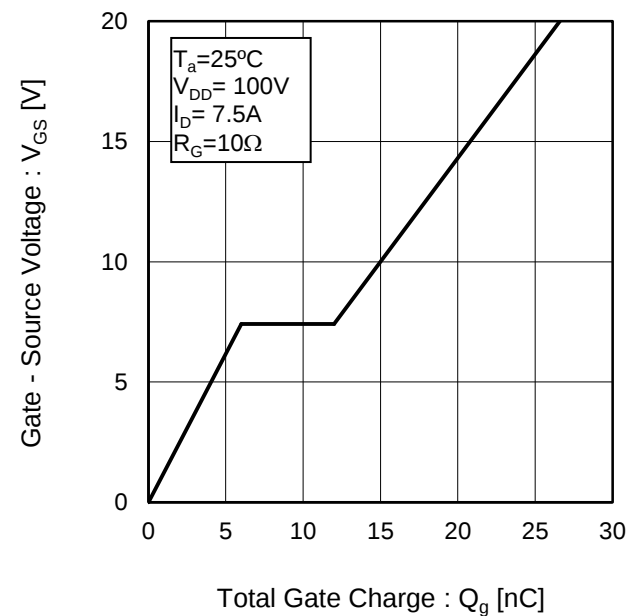


Fig.19 Dynamic Input Characteristics



●Electrical characteristic curves

Fig.20 Source Current  
vs. Source - Drain Voltage

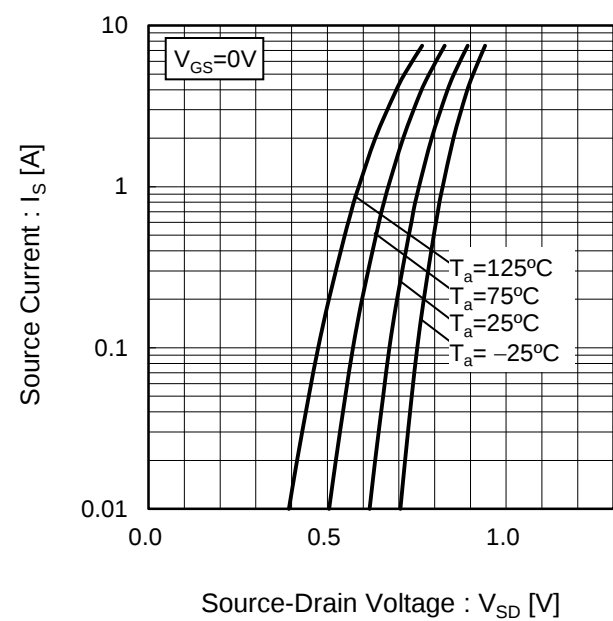
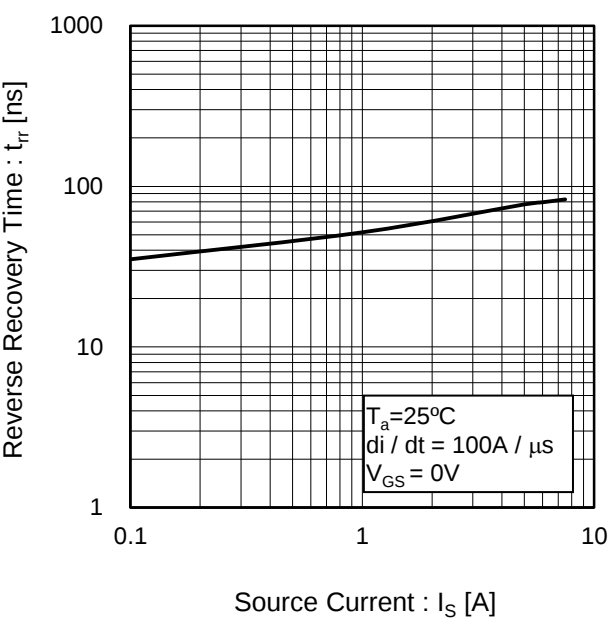


Fig21 Reverse Recovery Time  
vs.Source Current



●Measurement circuits

Fig.1-1 Switching Time Measurement Circuit

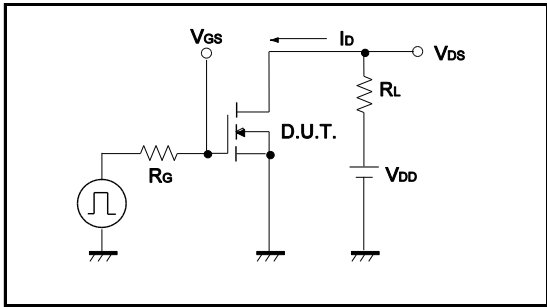


Fig.1-2 Switching Waveforms

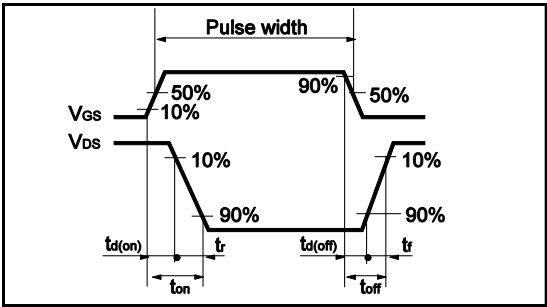


Fig.2-1 Gate Charge Measurement Circuit

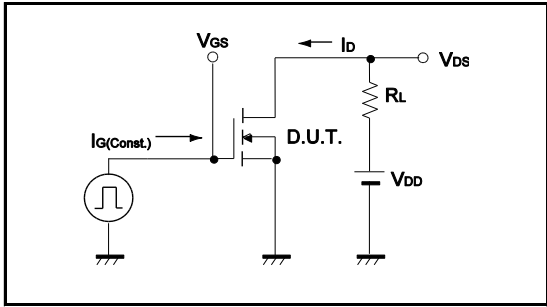


Fig.2-2 Gate Charge Waveform

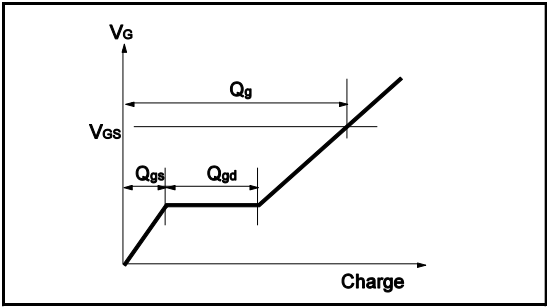


Fig.3-1 Avalanche Measurement Circuit

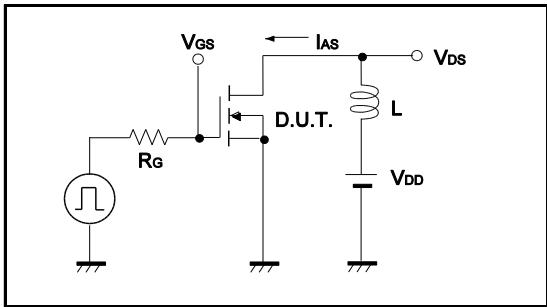
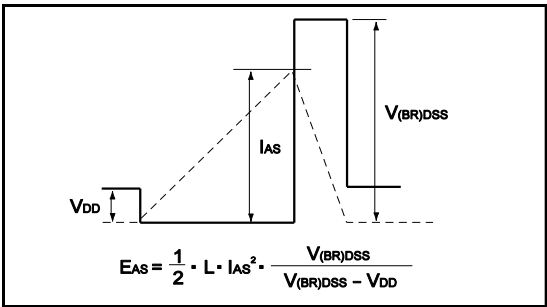
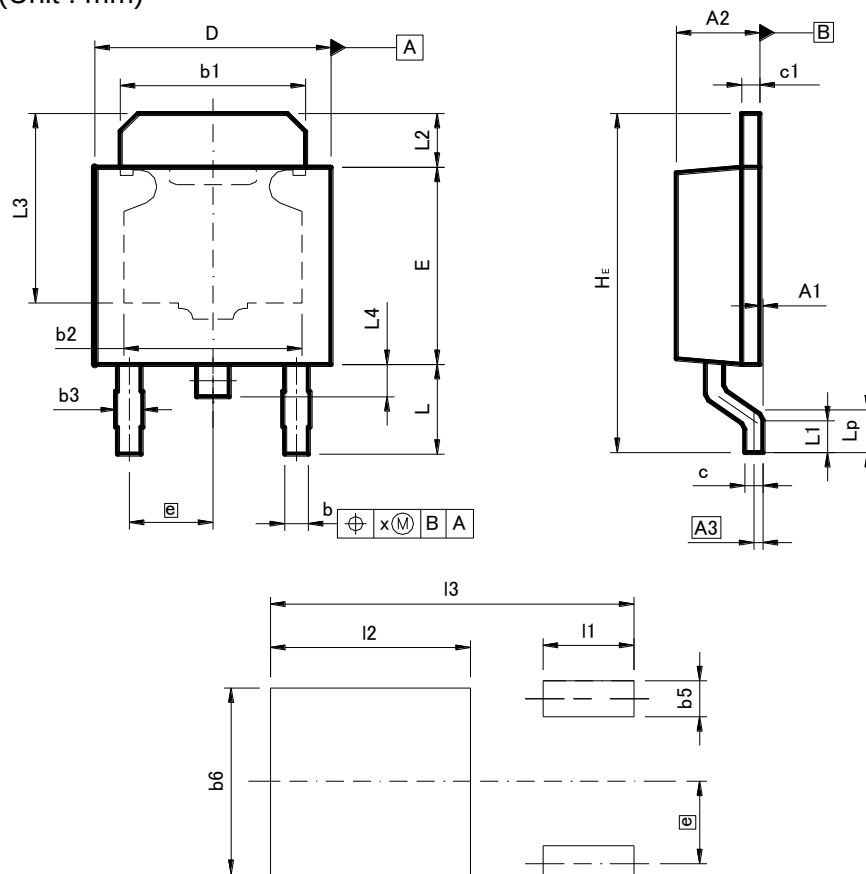


Fig.3-2 Avalanche Waveform



## ●Dimensions (Unit : mm)

CPT3



| DIM            | MILIMETERS |       | INCHES |       |
|----------------|------------|-------|--------|-------|
|                | MIN        | MAX   | MIN    | MAX   |
| A1             | 0.00       | 0.15  | 0      | 0.006 |
| A2             | 2.20       | 2.50  | 0.087  | 0.098 |
| A3             | 0.25       |       | 0.01   |       |
| b              | 0.55       | 0.75  | 0.022  | 0.03  |
| b1             | 5.00       | 5.30  | 0.197  | 0.209 |
| b2             | 5.00       |       | 0.20   |       |
| b3             | 0.75       |       | 0.03   |       |
| c              | 0.40       | 0.60  | 0.016  | 0.024 |
| c1             | 0.40       | 0.60  | 0.016  | 0.024 |
| D              | 6.30       | 6.70  | 0.248  | 0.264 |
| E              | 5.40       | 5.80  | 0.213  | 0.228 |
| e              | 2.30       |       | 0.09   |       |
| H <sub>E</sub> | 9.00       | 10.00 | 0.354  | 0.394 |
| L              | 2.20       | 2.80  | 0.087  | 0.11  |
| L1             | 0.80       | 1.40  | 0.031  | 0.055 |
| L2             | 1.20       | 1.80  | 0.047  | 0.071 |
| L3             | 5.30       |       | 0.209  |       |
| L4             | 0.90       |       | 0.035  |       |
| L <sub>p</sub> | 1.00       | 1.60  | 0.039  | 0.063 |
| x              | —          | 0.25  | —      | 0.01  |

| DIM | MILIMETERS |       | INCHES |       |
|-----|------------|-------|--------|-------|
|     | MIN        | MAX   | MIN    | MAX   |
| b5  | —          | 1.00  | —      | 0.04  |
| b6  | —          | 5.20  | —      | 0.205 |
| I1  | —          | 2.50  | —      | 0.098 |
| I2  | —          | 5.50  | —      | 0.217 |
| I3  | —          | 10.00 | —      | 0.394 |

Dimension in mm/inches

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